



May 1994

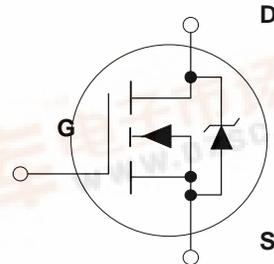
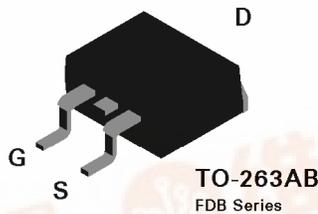
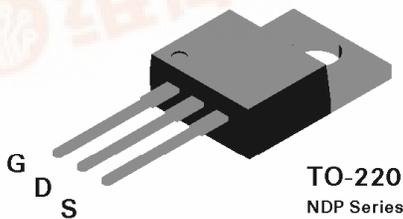
NDP708A / NDP708AE / NDP708B / NDP708BE NDB708A / NDB708AE / NDB708B / NDB708BE N-Channel Enhancement Mode Field Effect Transistor

General Description

These N-channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulses in the avalanche and commutation modes. These devices are particularly suited for low voltage applications such as automotive, DC/DC converters, PWM motor controls, and other battery powered circuits where fast switching, low in-line power loss, and resistance to transients are needed.

Features

- 60 and 54A, 80V. $R_{DS(ON)} = 0.022$ and 0.025Ω .
- Critical DC electrical parameters specified at elevated temperature.
- Rugged internal source-drain diode can eliminate the need for an external Zener diode transient suppressor.
- 175°C maximum junction temperature rating.
- High density cell design (3 million/in²) for extremely low $R_{DS(ON)}$.
- TO-220 and TO-263 (D²PAK) package for both through hole and surface mount applications.



Absolute Maximum Ratings

$T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	NDP708A NDB708A	NDP708AE NDB708AE	NDP708B NDB708B	NDP708BE NDB708BE	Units
V_{DSS}	Drain-Source Voltage	80		80		V
V_{DGR}	Drain-Gate Voltage ($R_{GS} \leq 1\text{ M}\Omega$)	80		80		V
V_{GSS}	Gate-Source Voltage - Continuous - Nonrepetitive ($t_p < 50\ \mu\text{s}$)	± 20		± 20		V
		± 40		± 40		V
I_D	Drain Current - Continuous - Pulsed	60	54	54	54	A
		180	162	162	162	A
P_D	Total Power Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	150		150		W
		1		1		W/ $^\circ\text{C}$
T_J, T_{STG}	Operating and Storage Temperature Range	-65 to 175		-65 to 175		$^\circ\text{C}$
T_L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	275		275		$^\circ\text{C}$



Electrical Characteristics ($T_c = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Type	Min	Typ	Max	Units
DRAIN-SOURCE AVALANCHE RATINGS (Note 1)							
E_{AS}	Single Pulse Drain-Source Avalanche Energy	$V_{DD} = 25\text{ V}$, $I_D = 60\text{ A}$	NDP708AE NDP708BE			600	mJ
I_{AR}	Maximum Drain-Source Avalanche Current		NDB708AE NDB708BE			60	A
OFF CHARACTERISTICS							
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}$, $I_D = 250\ \mu\text{A}$	ALL	80			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 80\text{ V}$, $V_{GS} = 0\text{ V}$	ALL			250	μA
		$T_J = 125^\circ\text{C}$				1	mA
I_{GSSF}	Gate - Body Leakage, Forward	$V_{GS} = 20\text{ V}$, $V_{DS} = 0\text{ V}$	ALL			100	nA
I_{GSSR}	Gate - Body Leakage, Reverse	$V_{GS} = -20\text{ V}$, $V_{DS} = 0\text{ V}$	ALL			-100	nA
ON CHARACTERISTICS (Note 2)							
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250\ \mu\text{A}$	ALL	2	2.6	4	V
		$T_J = 125^\circ\text{C}$		1.4	1.9	3.6	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS} = 10\text{ V}$, $I_D = 30\text{ A}$	NDP708A NDP708AE NDB708A NDB708AE		0.016	0.022	Ω
		$T_J = 125^\circ\text{C}$			0.025	0.04	Ω
		$V_{GS} = 10\text{ V}$, $I_D = 27\text{ A}$	NDP708B NDP708BE NDB708B NDB708BE			0.25	Ω
		$T_J = 125^\circ\text{C}$				0.044	Ω
$I_{D(on)}$	On-State Drain Current	$V_{GS} = 10\text{ V}$, $V_{DS} = 10\text{ V}$	NDP708A NDP708AE NDB708A NDB708AE	60			A
			NDP708B NDP708BE NDB708B NDB708BE	54			A
g_{FS}	Forward Transconductance	$V_{DS} = 10\text{ V}$, $I_D = 30\text{ A}$	ALL	16	33		S
DYNAMIC CHARACTERISTICS							
C_{iss}	Input Capacitance	$V_{DS} = 25\text{ V}$, $V_{GS} = 0\text{ V}$, $f = 1.0\text{ MHz}$	ALL		2800	3600	pF
C_{oss}	Output Capacitance		ALL		780	1000	pF
C_{riss}	Reverse Transfer Capacitance		ALL		285	400	pF

Electrical Characteristics (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Conditions	Type	Min	Typ	Max	Units
SWITCHING CHARACTERISTICS (Note 2)							
t _{D(ON)}	Turn - On Delay Time	V _{DD} = 40 V, I _D = 60 A, V _{GS} = 10 V, R _{GEN} = 5 Ω	ALL		15	25	nS
t _r	Turn - On Rise Time		ALL		143	230	nS
t _{D(OFF)}	Turn - Off Delay Time		ALL		58	90	nS
t _f	Turn - Off Fall Time		ALL		108	180	nS
Q _g	Total Gate Charge	V _{DS} = 64 V, I _D = 60 A, V _{GS} = 10 V	ALL		94	130	nC
Q _{gs}	Gate-Source Charge		ALL		16		nC
Q _{gd}	Gate-Drain Charge		ALL		51		nC
DRAIN-SOURCE DIODE CHARACTERISTICS							
I _S	Maximum Continuous Drain-Source Diode Forward Current		NDP708A NDP708AE NDB708A NDB708AE			60	A
			NDP708B NDP708BE NDB708B NDB708BE			54	A
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current		NDP708A NDP708AE NDB708A NDB708AE			180	A
			NDP708B NDP708BE NDB708B NDB708BE			162	A
V _{SD} (Note 2)	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 30 A	ALL		0.91	1.3	V
		T _J = 125°C			0.82	1.2	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _S = 60 A, di _S /dt = 100 A/μs	ALL		98	140	ns
I _{rr}	Reverse Recovery Current		ALL		6.5	10	A
THERMAL CHARACTERISTICS							
R _{θJC}	Thermal Resistance, Junction-to-Case		ALL			1	°C/W
R _{θJA}	Thermal Resistance, Junction-to-Ambient		ALL			62.5	°C/W

Notes:

1. NDP708A/708B and NDB708A/708B are not rated for operation in avalanche mode.
2. Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%.

Typical Electrical Characteristics

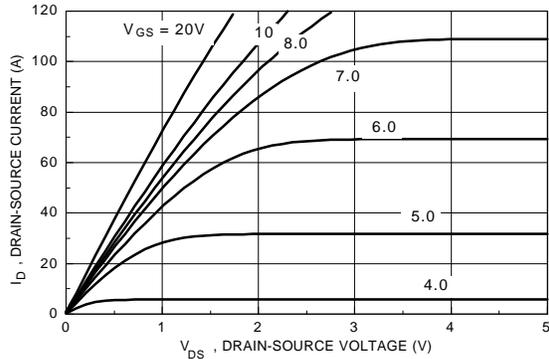


Figure 1. On-Region Characteristics.

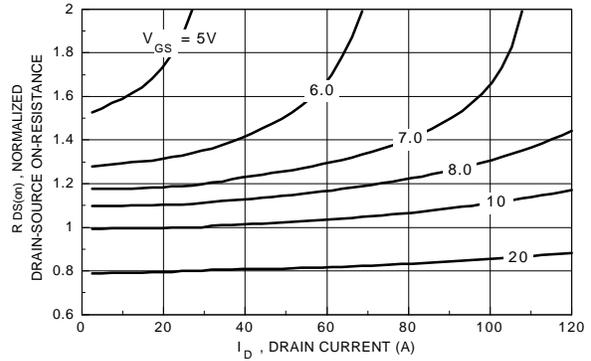


Figure 2. On-Resistance Variation with Gate Voltage and Drain Current.

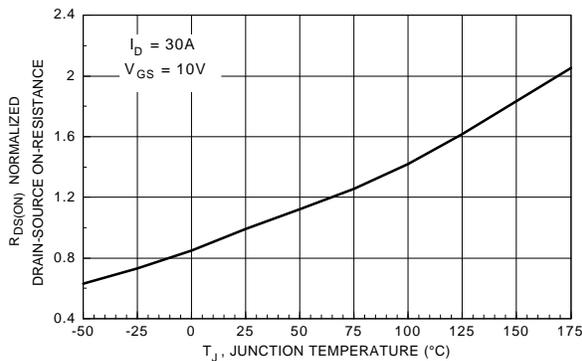


Figure 3. On-Resistance Variation with Temperature.

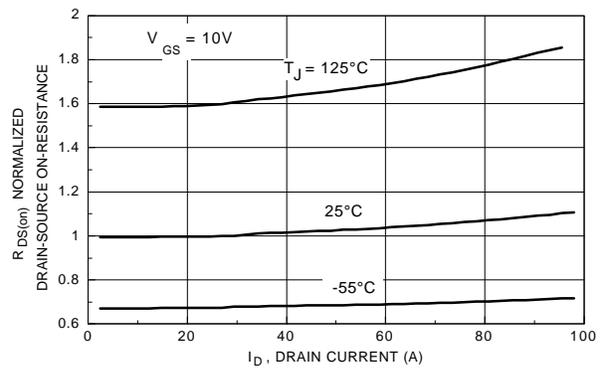


Figure 4. On-Resistance Variation with Drain Current and Temperature.

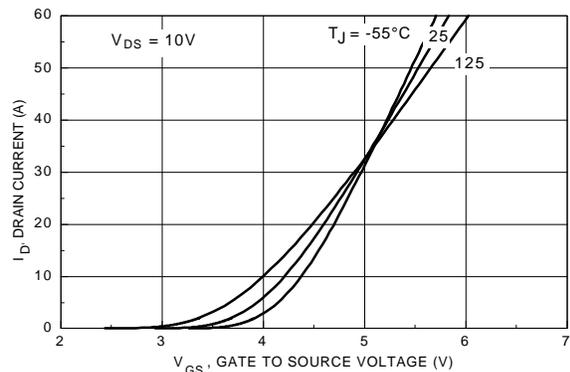


Figure 5. Transfer Characteristics.

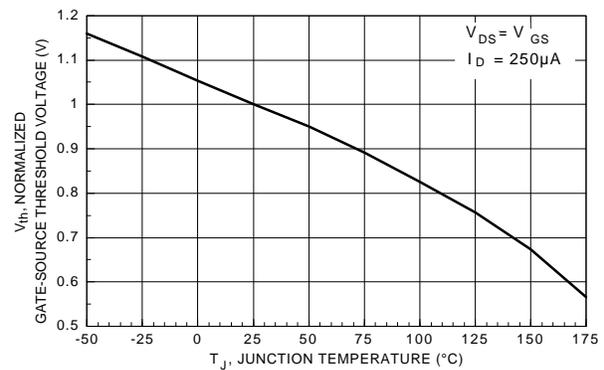


Figure 6. Gate Threshold Variation with Temperature.

Typical Electrical Characteristics (continued)

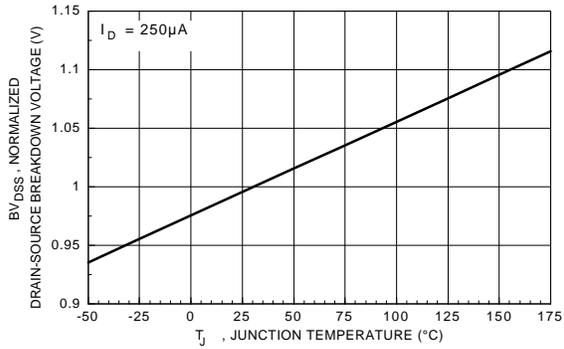


Figure 7. Breakdown Voltage Variation with Temperature.

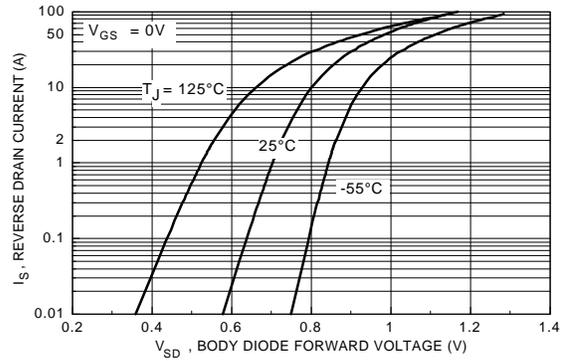


Figure 8. Body Diode Forward Voltage Variation with Current and Temperature.

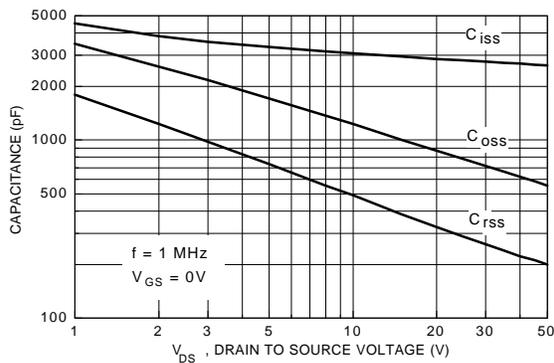


Figure 9. Capacitance Characteristics.

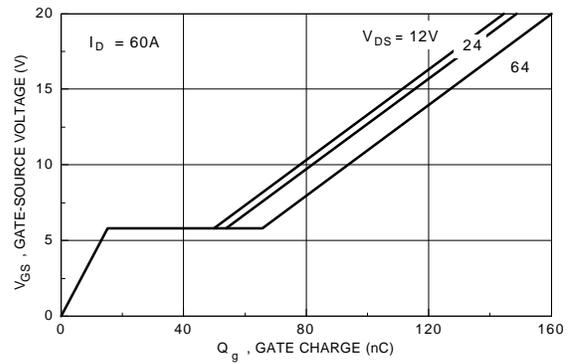


Figure 10. Gate Charge Characteristics.

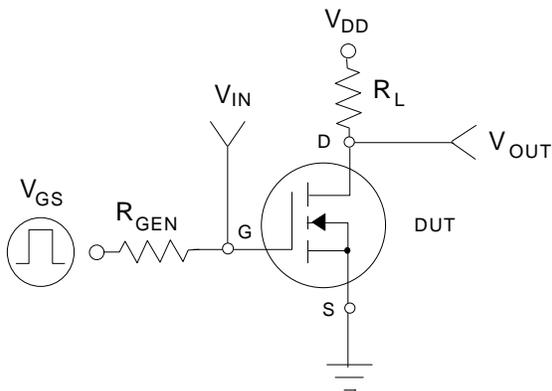


Figure 11. Switching Test Circuit.

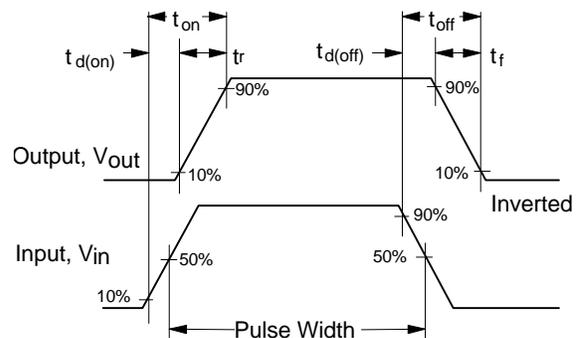


Figure 12. Switching Waveforms.

Typical Electrical Characteristics (continued)

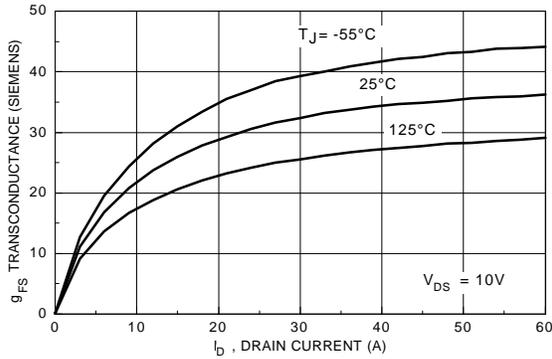


Figure 13. Transconductance Variation with Drain Current and Temperature.

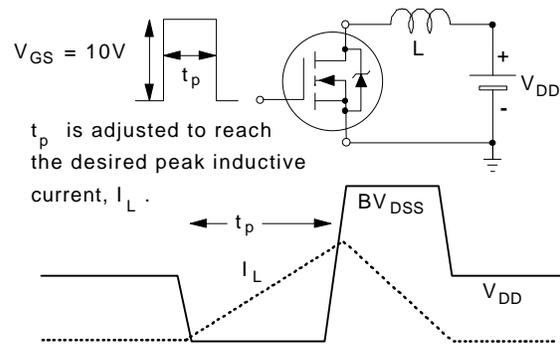


Figure 14. Unclamped Inductive Load Circuit and Waveforms.

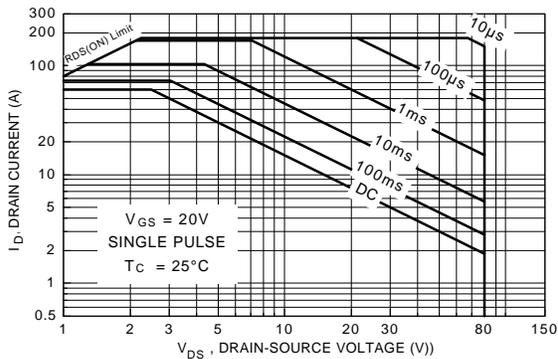


Figure 15. Maximum Safe Operating Area.

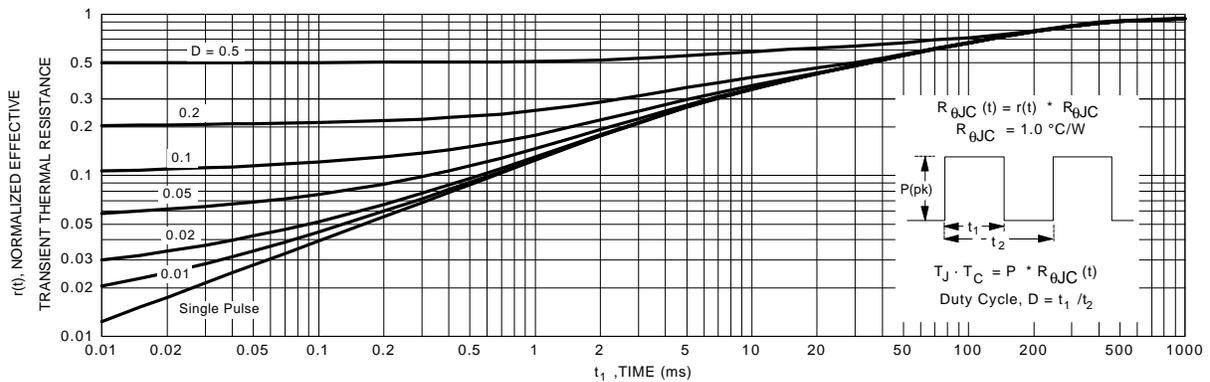


Figure 16. Transient Thermal Response Curve.